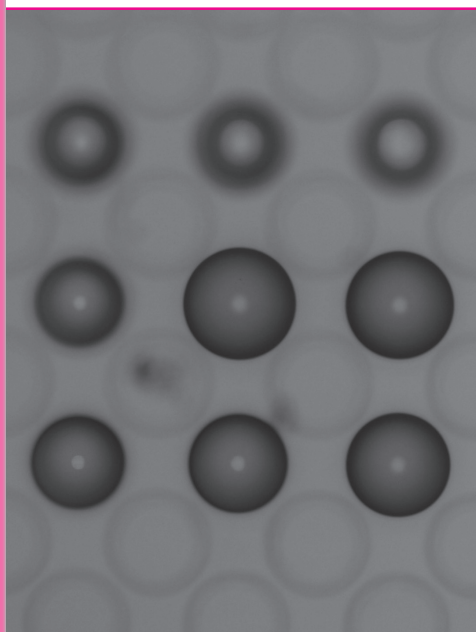


## Functional Materials for Inkjet Printing



- InkOrmo
- InkEpo
- mr-UVCur26SF

### Broad range of applications

- Optical components (transparency and stability)
- Packaging (stability)
- Nano Imprint Lithography (low residual layer thickness)
- Etch mask for plasma etching (stability)

### Unique features of our materials

- Compatible with commercial inkjet printing equipment
- Tailored for stable drop generation
- UV-curable formulations

- Made in Germany -



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Product overview

Inks <sup>1</sup>	InkOrmo <sup>*</sup> series	InkEpo <sup>*</sup> series	mr-UVCur26SF
Type of material	Optical polymer	Optical polymer	Resist

Properties before UV-curing

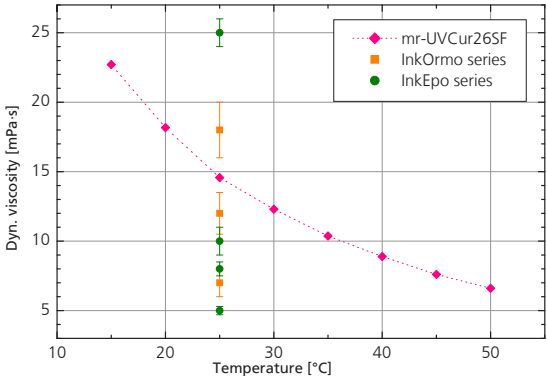
Viscosity at room temperature (25 °C) [mPa·s]	7.0 ± 1.0 12 ± 1.5 18 ± 2	5.0 ± 0.3 8.0 ± 0.5 12 ± 1 25 ± 1	15 ± 2
Solvent free	No	No	Yes
Photo curing spectral sensitivity [nm]	300 – 410	300 – 390	365 – 405 <sup>2</sup>
Oxygen sensitive curing	No	No	Yes <sup>3</sup>

Properties after UV-curing

RI (at 589 nm) after curing	1.517 – 1.520 <sup>4</sup>	1.555 <sup>4</sup>	1.518
CTE (20 – 100 °C) [ppm/K]	60	~ 50	n/a
dn/dT [10 <sup>-4</sup> /K]	-2.0	-0.7	TBD
Young Modulus [GPa]	~ 1	~ 2	n/a
Hardness (indentation) [MPa]	68 ± 1	-	n/a
Water absorption	< 0.5%	< 0.5%	TBD

<sup>1</sup> Our inks are compatible and have been tested on several inkjet printing tools. List available upon request <sup>2</sup> Hg bulb lamp or monochromatic LED <sup>3</sup> Formation of an inhibition layer when UV-cured in presence of oxygen <sup>4</sup> Depends on hard-bake conditions

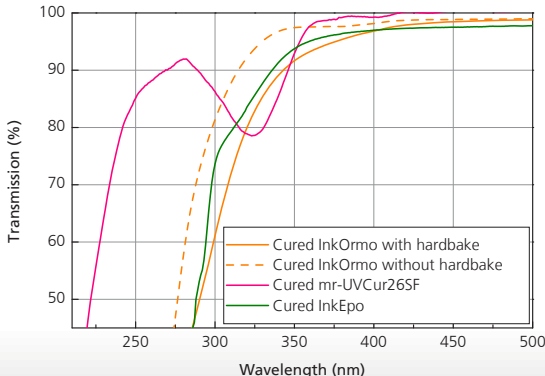
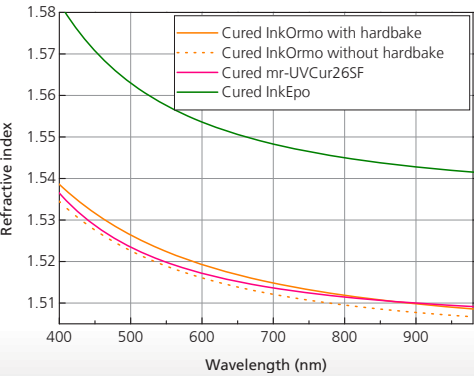
Viscosity



Specific properties

- InkOrmo<sup>\*</sup> and InkEpo<sup>\*</sup>**
- Permanent applications
  - Optimized for optical applications
  - High thermal stability up to 300 °C (short term), 270 °C (long term)
  - High physical and chemical stability
  - Excellent mechanical properties
- mr-UVCur26SF**
- Solvent-free ink
  - Compatible with NIL<sup>\*\*</sup> process
  - Optimized for easy demolding after NIL
  - Excellent plasma etch resistance
  - No evaporation of formulation components

Optical properties

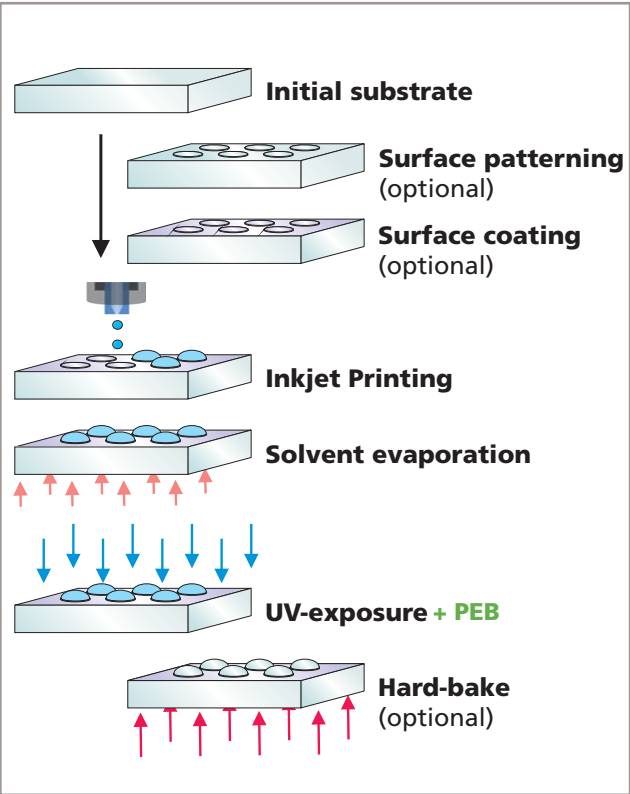


<sup>1</sup> The transmission is given for a thickness of 20 µm for InkOrmo, and a thickness of 1 µm for InkEpo and mr-UVCur26SF

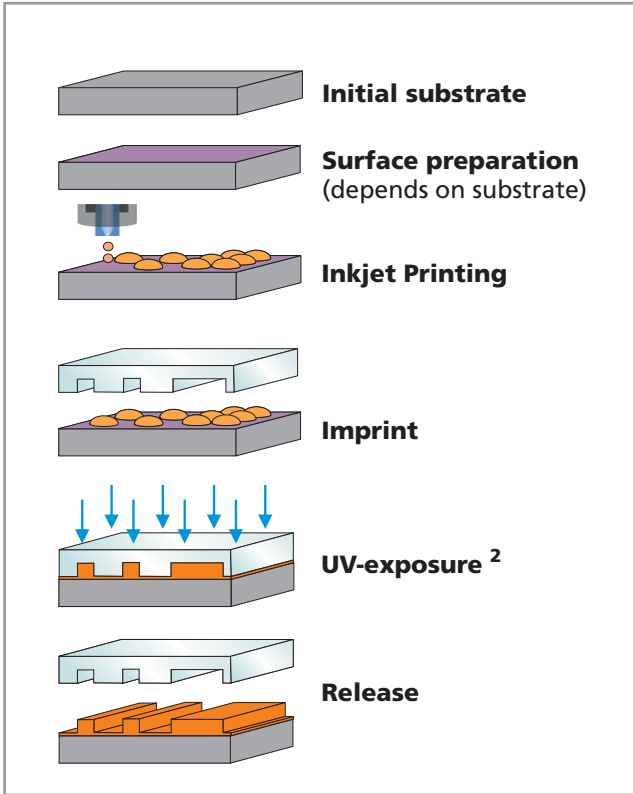
<sup>\*</sup>Inkjettable optical polymers: EP 2 159 040 B1 „Micro optical articles, process for their production and uses“  
<sup>\*\*</sup>NIL stands for Nano Imprint Lithography

Processing examples

Example for microlens fabrication  
InkOrmo and InkEpo



Example for NIL  
mr-UVCur26SF



<sup>1</sup> The solvent evaporation step can be done with or without heating depending on process constraints <sup>2</sup> Either the substrate or the stamp needs to be transparent in the range of 365 – 405 nm

Substrate preparation

Adhesion

- Adhesion improved by the use of an adhesion promoter

**InkOrmo** - OrmoPrime®08    **InkEpo** - not required    **mr-UVCur26SF** - mr-APS1

Surface energy modification

- The profile of the printed droplet can be controlled by modifying the substrate surface energy

**InkOrmo & InkEpo** - Allows to reach a higher / lower profile    **mr-UVCur26SF** - Allows to increase the volume deposited / surface area for high-aspect-ratio NIL cavities

Surface pre-pattern

- Possible to print on substrates involving topography

**InkOrmo & InkEpo** - Topography can be specifically designed to confine InkOrmo onto desired locations

Process highlights and possible continuations

- Process compatible to non-flat as well as curved substrates and roll-to-roll (R2R)
- High compatibility to processes leading to high throughput and monolithic components

Suggested applications

**InkOrmo & InkEpo**

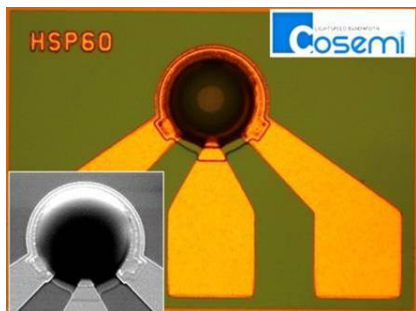
- Microlenses (single or arrays)
- Optical waveguides
- Optical couplers and connectors
- Diffractive optical elements
- Microfluidic systems

**mr-UVCur26SF**

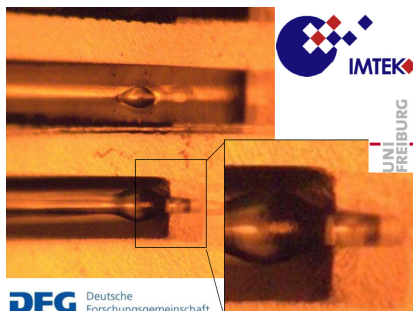
- Step & Repeat NIL processes
- Large-area nanostructuring of flexible substrates
- Continuous R2R photo-NIL processes
- High volume manufacturing on flexible substrates of:
  - Antireflective coatings
  - (Super)Hydrophobic patterns
  - Wire-grid polarizers

## Application examples

### InkOrmo

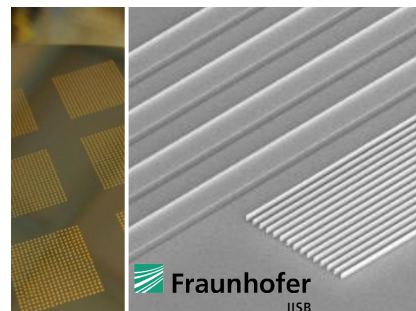


InkOrmo microlens printed on pre-patterned substrate, diameter of 100 µm (Printed at EPFL, Courtesy of Cossemi Technologies Inc., USA)



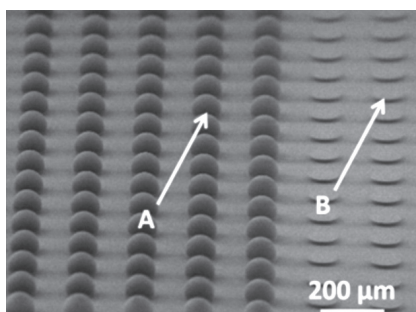
Inkjet-printed waveguide with 100 µm core and 300 µm cladding. (Courtesy of IMTEK, Germany, 2)

### mr-UVCur265F

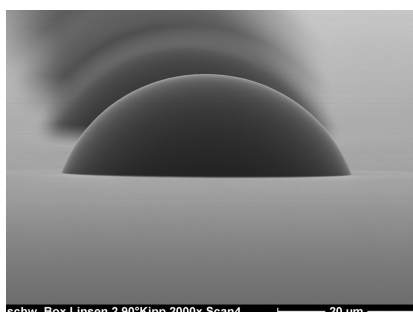


Left: Inkjet dispensed droplets. Right: subsequent imprinted submicrometer lines. (Courtesy of Fraunhofer IISB, Germany, 5)

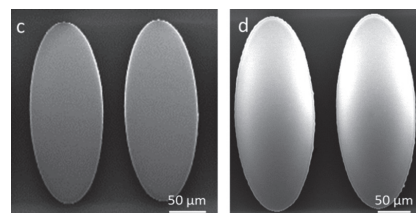
### InkEpo



Array of InkEpo microlenses on 100 µm wide Si platforms (A) lenses on a platform, (B) empty platforms. (Courtesy of EPFL, Switzerland)



SEM pictures of cured InkEpo lens with Ø 45 µm, 10 drops per lenses on surface-treated glass slides. (Courtesy of EPFL, Switzerland)

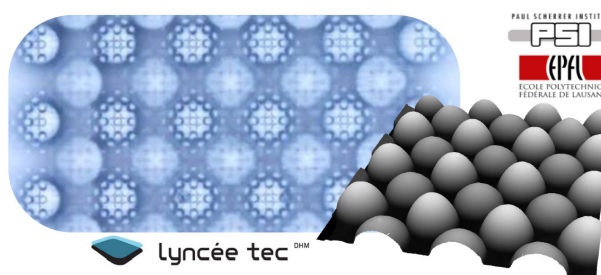
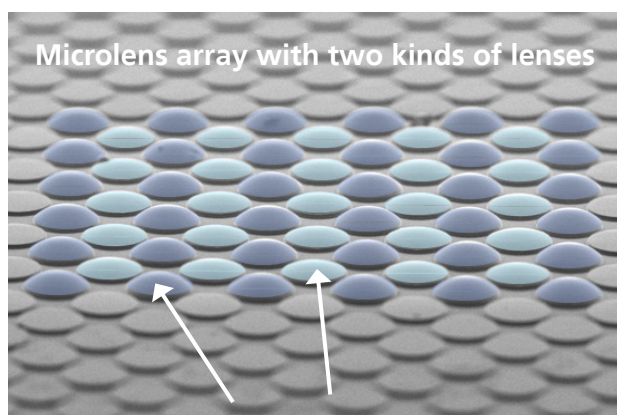
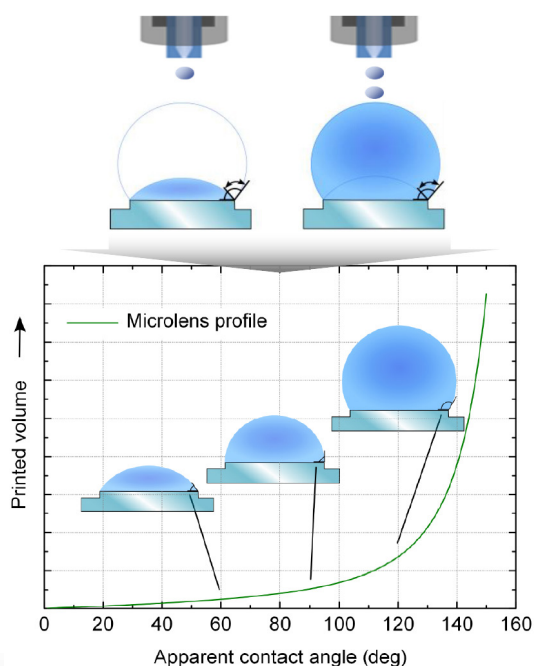


SEM images of (c) SU-8 platforms and (d) the corresponding lenses after performing the IJP of the InkEpo onto the platforms. (Courtesy of EPFL, Switzerland)

## Application note

### InkOrmo microlenses with specific profile by confining the microlens footprint

- Footprint topography or chemically confined
- Direct printing of final microlenses
- Specified and controlled lens profile



InkOrmo microlens with different optical characteristics (Cooperation with EPFL, PSI and Lyncée Tec, Switzerland)